

PRODUCT FEATURES

- IGBT³ CHIP(Trench+Field Stop technology)
- High short circuit capability,self limiting short circuit current
- $V_{CE(sat)}$ with positive temperature coefficient
- Fast switching and short tail current
- Free wheeling diodes with fast and soft reverse recovery
- Low switching losses



APPLICATIONS

- High frequency switching application
- Medical applications
- Motion/servo control
- UPS systems

IGBT-inverter

ABSOLUTE MAXIMUM RATINGS($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
V_{CES}	Collector Emitter Voltage	$T_J=25^\circ\text{C}$	600	V
V_{GES}	Gate Emitter Voltage		± 20	
I_C	DC Collector Current	$T_C=25^\circ\text{C}$	240	A
		$T_C=60^\circ\text{C}$	200	
I_{CM}	Repetitive Peak Collector Current	$tp=1\text{ms}$	400	
P_{tot}	Power Dissipation Per IGBT		600	W

Diode-inverter

ABSOLUTE MAXIMUM RATINGS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
V_{RRM}	Repetitive Reverse Voltage	$T_J=25^\circ\text{C}$	600	V
$I_{F(AV)}$	Average Forward Current	$T_C=25^\circ\text{C}$	200	A
I_{FRM}	Repetitive Peak Forward Current	$tp=1\text{ms}$	400	
I^2t		$T_J=125^\circ\text{C}, t=10\text{ms}, V_R=0\text{V}$	3500	A^2S

IGBT-inverter

ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit	
$V_{GE(th)}$	Gate Emitter Threshold Voltage	$V_{CE}=V_{GE}, I_C=3.2\text{mA}$	4.9	5.8	6.5	V	
$V_{CE(sat)}$	Collector Emitter Saturation Voltage	$I_C=200\text{A}, V_{GE}=15\text{V}, T_J=25^\circ\text{C}$		1.45	1.9		
		$I_C=200\text{A}, V_{GE}=15\text{V}, T_J=125^\circ\text{C}$		1.6			
I_{CES}	Collector Leakage Current	$V_{CE}=600\text{V}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$			1	mA	
		$V_{CE}=600\text{V}, V_{GE}=0\text{V}, T_J=125^\circ\text{C}$			5	mA	
I_{GES}	Gate Leakage Current	$V_{CE}=0\text{V}, V_{GE}=\pm 15\text{V}, T_J=25^\circ\text{C}$	-400		400	nA	
R_{gint}	Integrated Gate Resistor			2		Ω	
Q_g	Gate Charge	$V_{CE}=300\text{V}, I_C=200\text{A}, V_{GE}=\pm 15\text{V}$		2.15		μC	
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$		13		nF	
C_{res}	Reverse Transfer Capacitance				380		pF
$t_{d(on)}$	Turn on Delay Time	$V_{CC}=300\text{V}, I_C=200\text{A}$ $R_G=2.0\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		150		ns
			$T_J=125^\circ\text{C}$		160		ns
t_r	Rise Time	Inductive Load	$T_J=25^\circ\text{C}$		30		ns
			$T_J=125^\circ\text{C}$		40		ns
$t_{d(off)}$	Turn off Delay Time	$V_{CC}=300\text{V}, I_C=200\text{A}$ $R_G=2.0\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		340		ns
			$T_J=125^\circ\text{C}$		370		ns
t_f	Fall Time	Inductive Load	$T_J=25^\circ\text{C}$		60		ns
			$T_J=125^\circ\text{C}$		70		ns
E_{on}	Turn on Energy	$V_{CC}=300\text{V}, I_C=200\text{A}$ $R_G=2.0\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		1		mJ
			$T_J=125^\circ\text{C}$		1.55		mJ
E_{off}	Turn off Energy	Inductive Load	$T_J=25^\circ\text{C}$		5.65		mJ
			$T_J=125^\circ\text{C}$		6.90		mJ
I_{sc}	Short Circuit Current	$t_{psc}\leq 6\mu\text{s}, V_{GE}=15\text{V}$ $T_J=125^\circ\text{C}, V_{CC}=360\text{V}$		1000		A	
R_{thJC}	Junction to Case Thermal Resistance (Per IGBT)				0.25	K/W	

Diode-inverter

ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
V_F	Forward Voltage	$I_F=200\text{A}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$		1.55	1.95	V
		$I_F=200\text{A}, V_{GE}=0\text{V}, T_J=125^\circ\text{C}$		1.50		
t_{rr}	Reverse Recovery Time	$I_F=200\text{A}, V_R=300\text{V}$		170		ns
I_{RRM}	Max. Reverse Recovery Current	$di_F/dt=-5700\text{A}/\mu\text{s}$		230		A
Q_{RR}	Reverse Recovery Charge	$T_J=125^\circ\text{C}$		17		μC
E_{rec}	Reverse Recovery Energy			5.2		mJ
R_{thJCD}	Junction to Case Thermal Resistance (Per Diode)				0.45	K/W

NTC CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
R_{25}	Resistance	$T_C = 25^\circ\text{C}$		5		K Ω
$B_{25/50}$	$R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298.15 \text{ K}))]$			3375		K

MODULE CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit	
T_{Jmax}	Max. Junction Temperature		175	°C	
T_{Jop}	Operating Temperature		-40~150		
T_{stg}	Storage Temperature		-40~125		
V_{isol}	Isolation Breakdown Voltage		AC, 50Hz(R.M.S), t=1minute	3000	V
Torque	to heatsink	Recommended (M6)	3~5	Nm	
	to terminal	Recommended (M5)	2.5~5	Nm	
Weight			200	g	

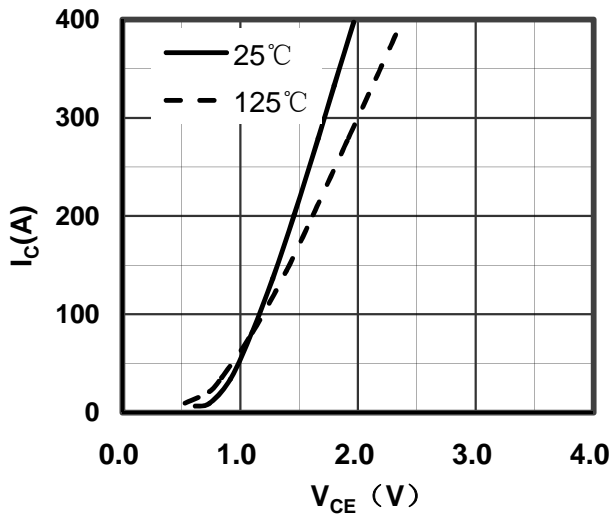


Figure 1. Typical Output Characteristics IGBT-inverter

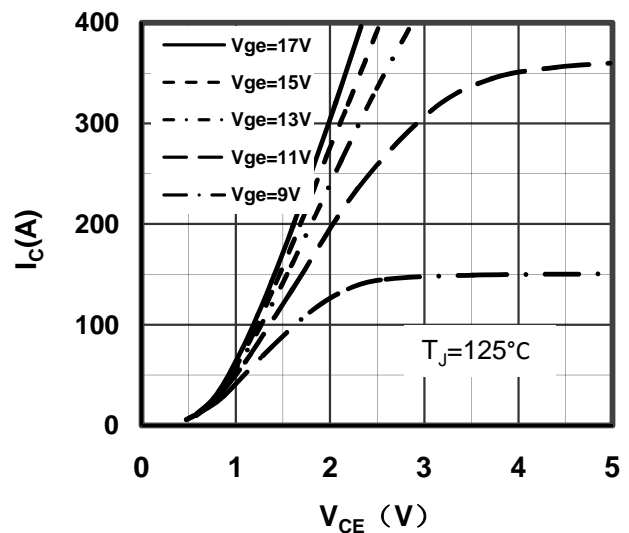


Figure 2. Typical Output Characteristics IGBT-inverter

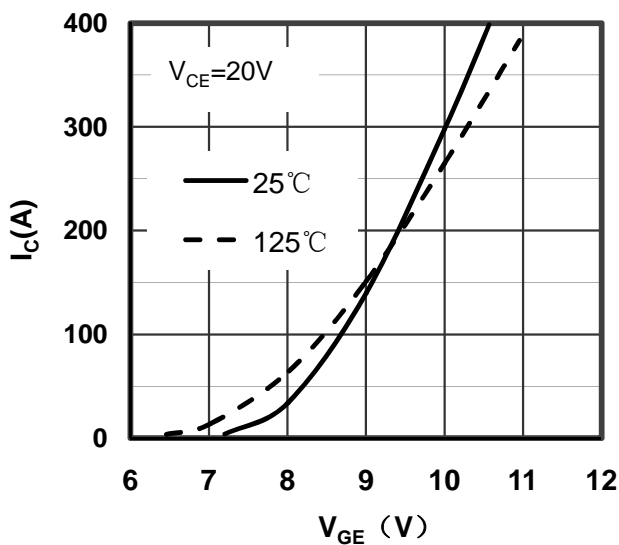


Figure 3. Typical Transfer Characteristics IGBT-inverter

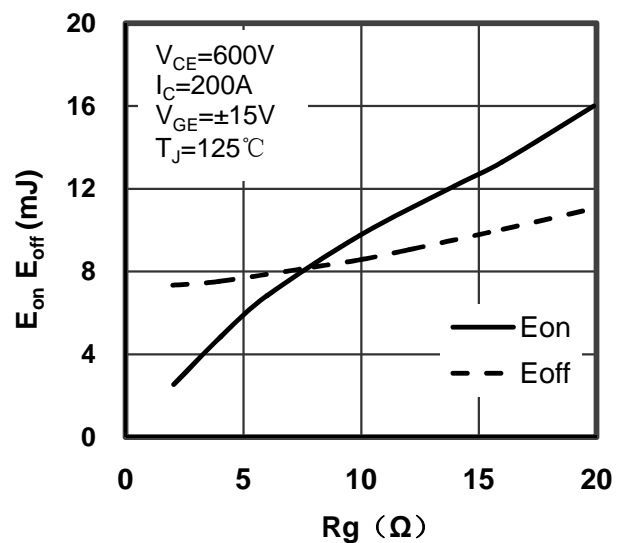


Figure 4. Switching Energy vs Gate Resistor IGBT-inverter

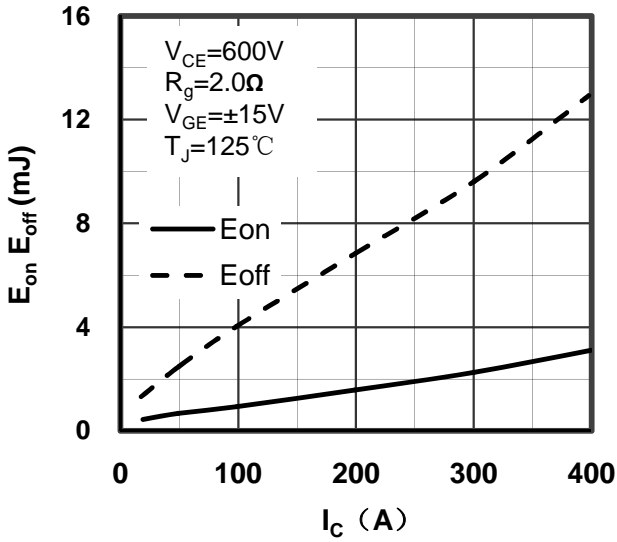


Figure 5. Switching Energy vs Collector Current IGBT-inverter

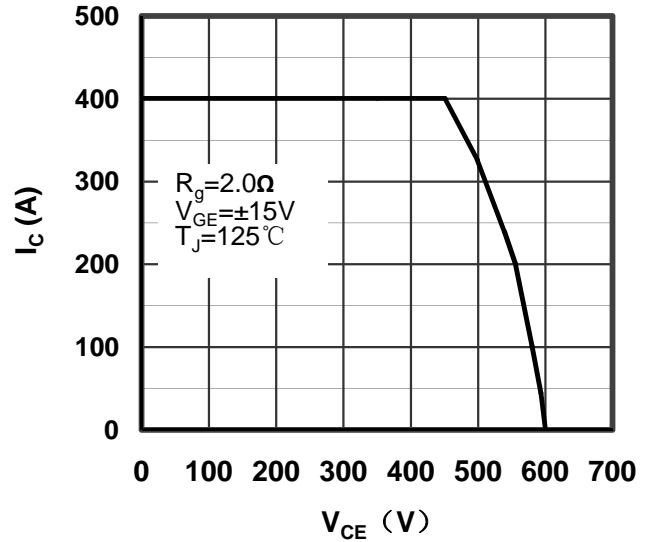


Figure 6. Reverse Biased Safe Operating Area IGBT-inverter

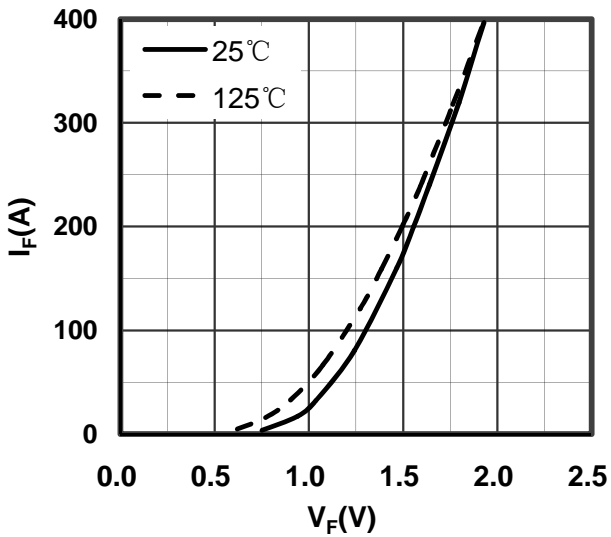


Figure 7. Diode Forward Characteristics Diode-inverter

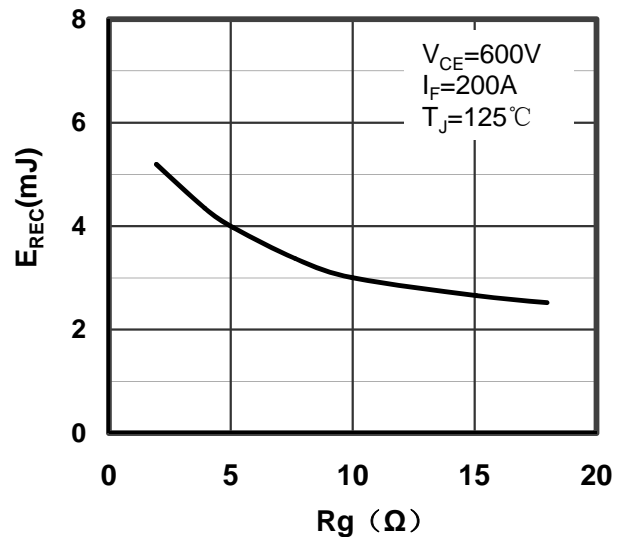


Figure 8. Switching Energy vs Gate Resistor Diode-inverter

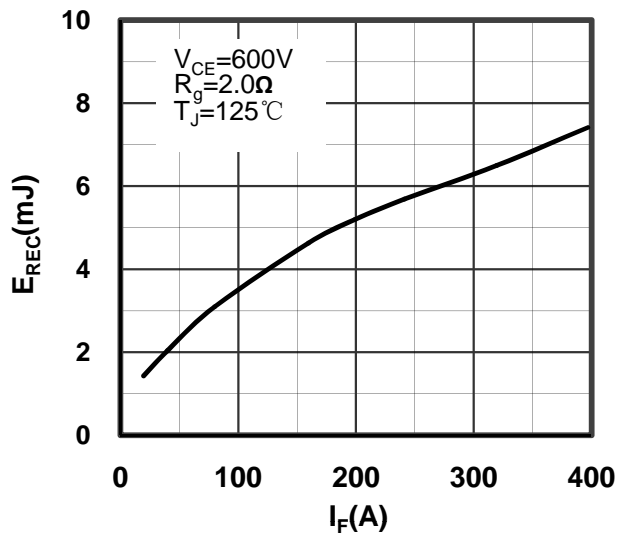


Figure 9. Switching Energy vs Forward Current Diode-inverter

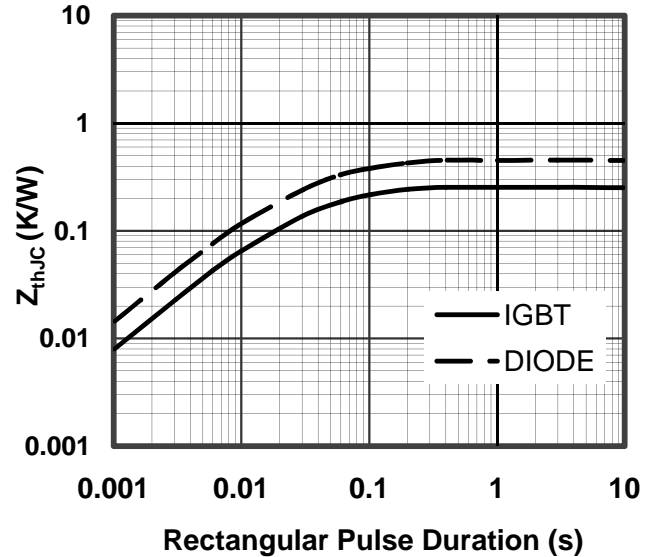


Figure 10. Transient Thermal Impedance of Diode and IGBT-inverter

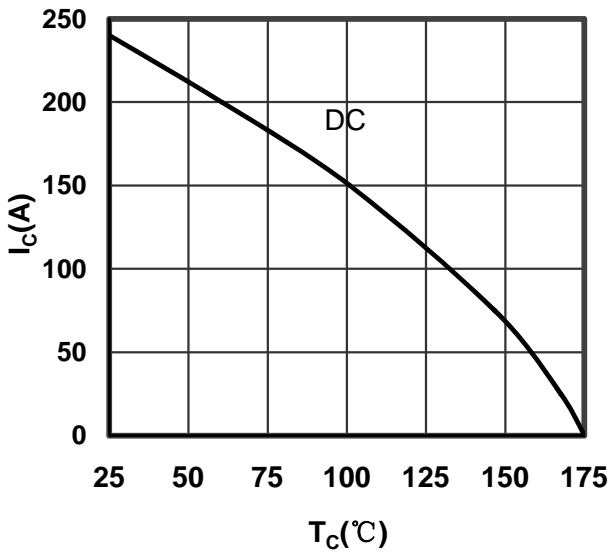


Figure 11. Collector Current vs Case temperature IGBT -inverter

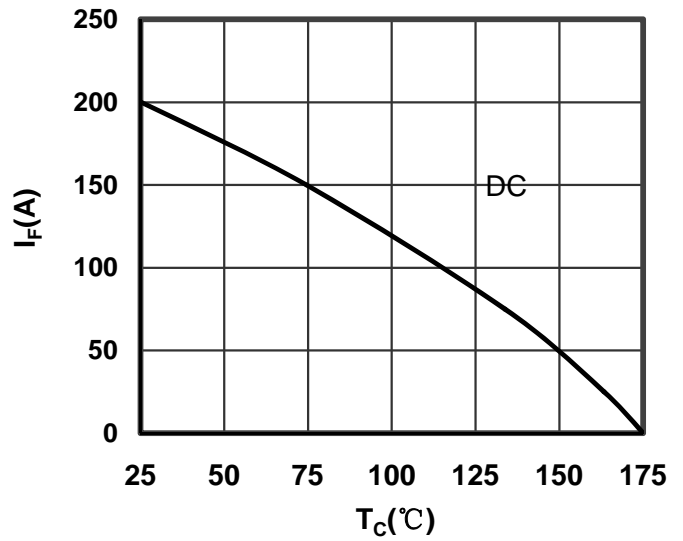


Figure 12. Forward current vs Case temperature Diode -inverter

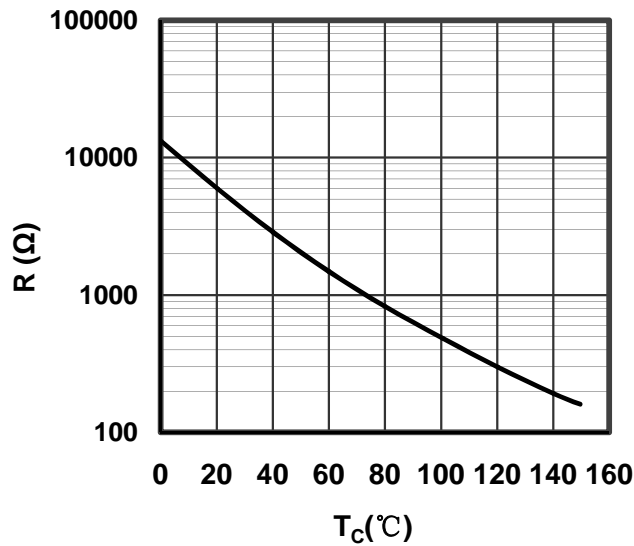


Figure 13. NTC Characteristics

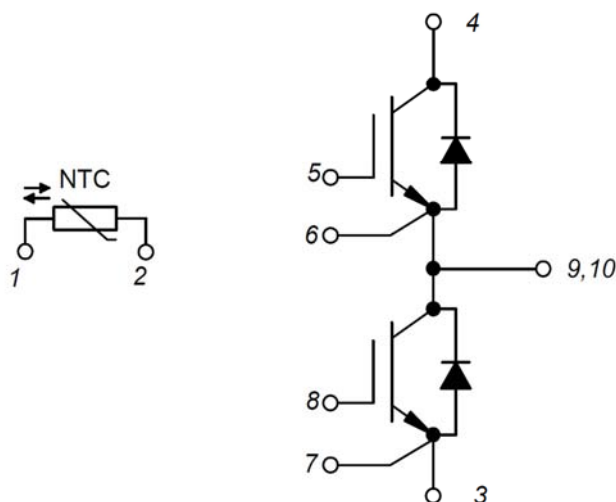
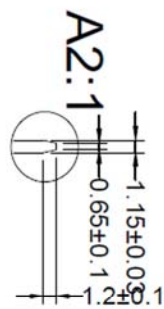
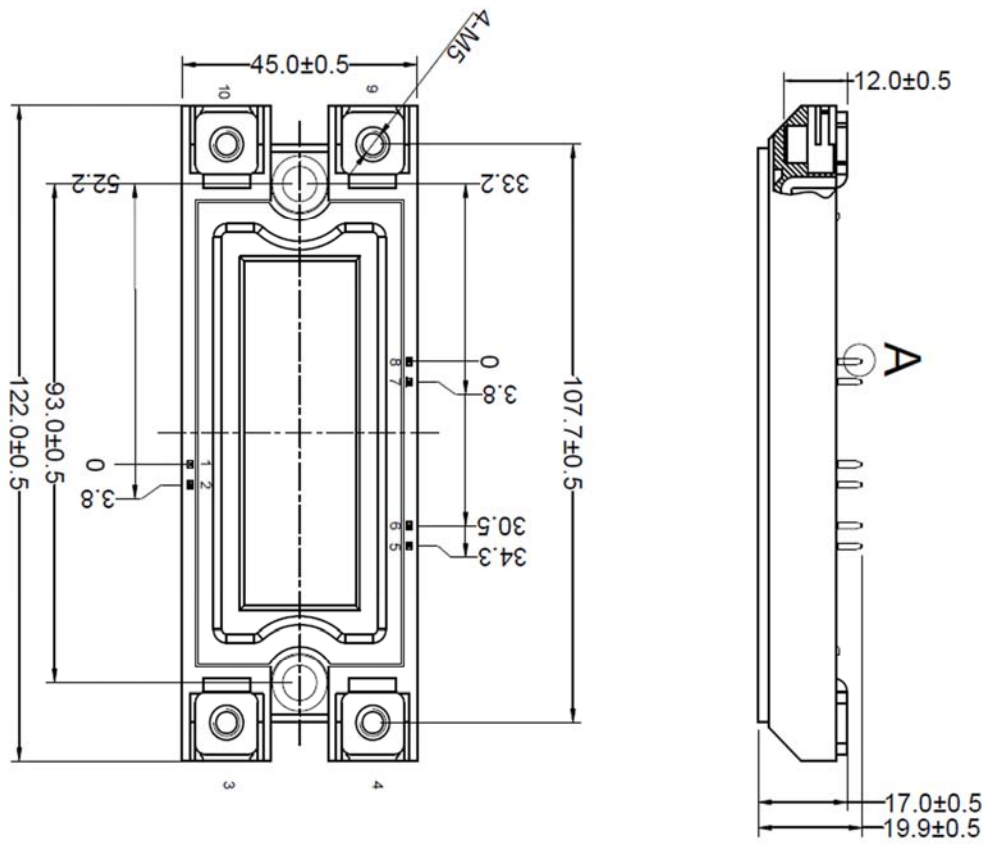


Figure 14. Circuit Diagram



Dimensions in (mm)
Figure 15. Package Outline